

N-channel 100 V, 0.065 Ω typ., 4 A STripFET™ II Power MOSFET in SO-8 package

Datasheet - production data

Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STS4NF100	100 V	$0.070~\Omega$	4 A

- Exceptional dv/dt capability
- 100 % avalanche tested
- Application oriented characterization

Applications

■ Switching applications

Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

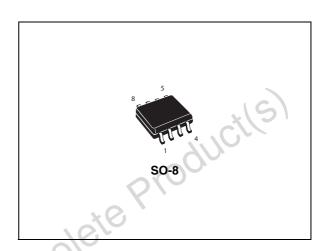


Figure 1. Internal schematic diagram

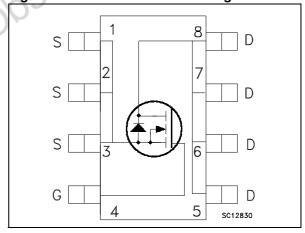


Table 1. Device summary

Order code	Marking	Package	Packaging	
STS4NF100	4NF100	SO-8	Tape and reel	

Contents STS4NF100

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00501	Electrical characteristics

STS4NF100 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	100	V
V _{GS}	Gate- source voltage	±20	V
I _D	Drain current (continuous) at T _C = 25°C	4	Α
I _D	Drain current (continuous) at T _C = 100°C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT}	Total dissipation at T _{amb} = 25°C	2.5	W
TJ	Max. operating junction temperature	-55 to 150	°C
T _{stg}	Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-a}	Thermal resistance junction-ambient max (1)	50	°C/W

^{1.} Mounted on FR-4 board (t 10 sec.)

Electrical characteristics STS4NF100

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	100			V
1	Zero gate voltage	V _{DS} = 100 V			1	μΑ
I _{DSS}	drain current (V _{GS} = 0)	V _{DS} = 100 V, T _C =125 °C			10	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V		(±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	٧
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 2 A	Oyo	0.065	0.070	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} x R_{DS(on)max}$ $I_D = 2 A$	1	10		S
C _{iss}	Input capacitance		-	870		pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	125		pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	52		pF
Qg	Total gate charge		-	30	41	nC
Q_{gs}	Gate-source charge	$V_{DD} = 80 \text{ V}, I_{D} = 4 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	6		nC
Q_{gd}	Gate-drain charge	- GS = 10 T	-	10		nC

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5 .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time rise time	V_{DD} =50 V, I_{D} =4 A, R_{G} =4.7 Ω , V_{GS} = 10 V (see <i>Figure 14</i>)	-	58 45	-	ns ns
t _{d(off)}	Turn-off delay time fall time	$V_{DD} = 50 \text{ V}, I_D = 4 \text{ A}$ $R_G=4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 14)	-	49 17	-	ns ns

Table 7. Source drain diode

Table 7.	Source drain diode	Source drain diode				
Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		4	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		16	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 4 A, V_{GS} = 0$	-		1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 4 \text{ A}, V_{DD} = 30 \text{ V}$ di/dt = 100 A/ μ s, $T_j = 150 ^{\circ}\text{C}$ (see <i>Figure 15</i>)	-	100 375 7.5		ns nC A
1 Pulso wi	Reverse recovery current oth limited by safe operating area. Pulse duration = 300 µs, duty cycle 1.5	(see Figure 15)		7.5		— A
1. Pulse wi	dth limited by safe operating area.					
2. Pulsed: F	Pulse duration = 300 µs, duty cycle 1.5	%			JC	
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Electrical characteristics STS4NF100

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

I_D(A)

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Figure 3. Thermal impedance

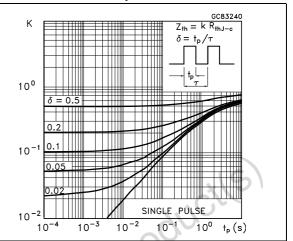


Figure 4. Output characterisics

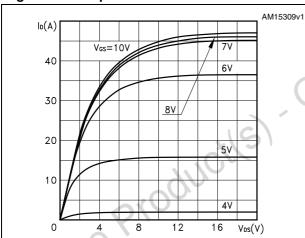


Figure 5. Transfer characteristics

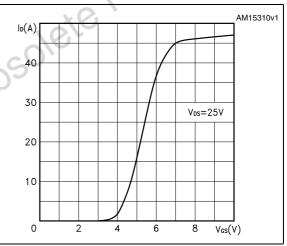


Figure 6. Transconductance

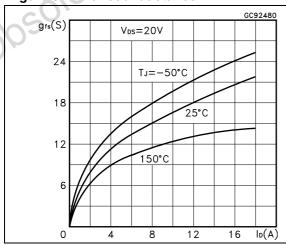
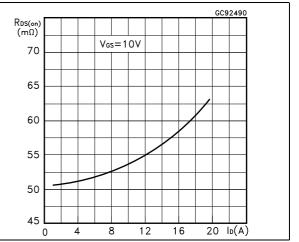


Figure 7. Static drain-source on-resistance



AM15312v1
Vgs(V)
Vgs=80V
Ip= 4A

12

9

6

3

C(pF)

F=1MHz
Vgs=0V

1200

600

Coss

Coss

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Q_g(nC)

Figure 10. Normalized gate threshold voltage vs temperature

16

24

Figure 11. Normalized on-resistance vs temperature

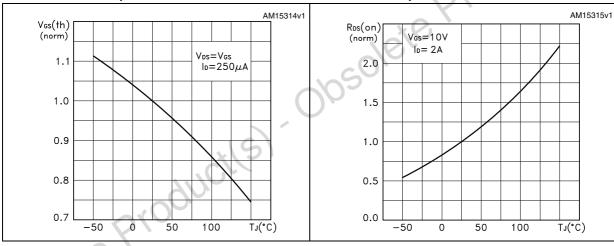
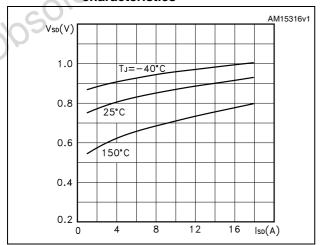


Figure 12. Source-drain diode forward characteristics



Test circuit STS4NF100

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

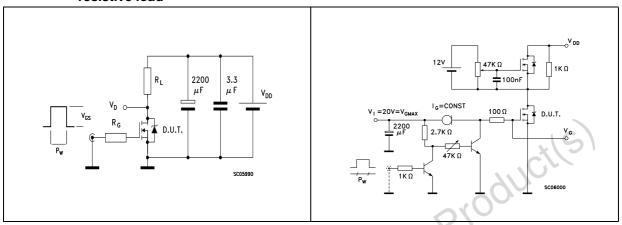


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

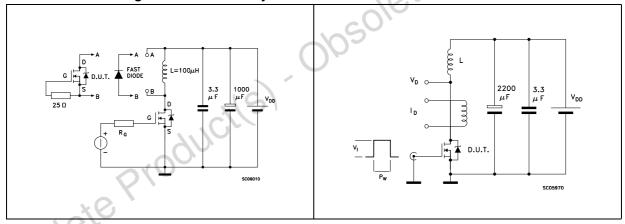
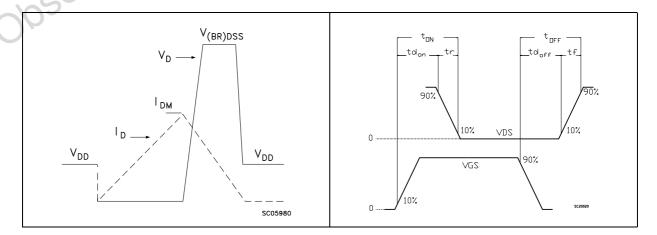


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



4 Package mechanical data

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Obsolete Product(s). Obsolete Product(s)

Table 8. SO-8 mechanical data

Dim.	mm					
Diiii.	Min.	Тур.	Max.			
Α			1.75			
A1	0.10		0.25			
A2	1.25					
b	0.31		0.51			
b1	0.28		0.48			
С	0.10		0.25			
c1	0.10		0.23			
D	4.80	4.90	5.00			
Е	5.80	6.00	6.20			
E1	3.80	3.90	4.00			
е		1.27				
h	0.25	76/	0.50			
L	0.40	°CO,	1.27			
L1		1.04				
L2		0.25				
k	0°		8°			
ccc			0.10			

Figure 19. SO-8 drawing

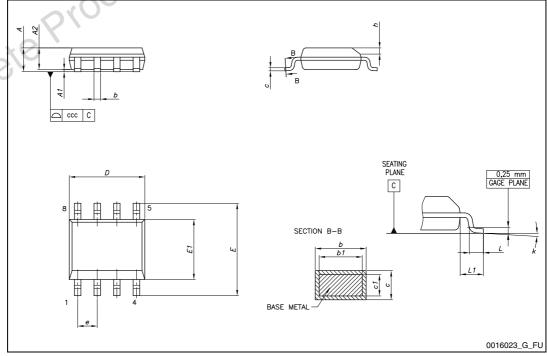
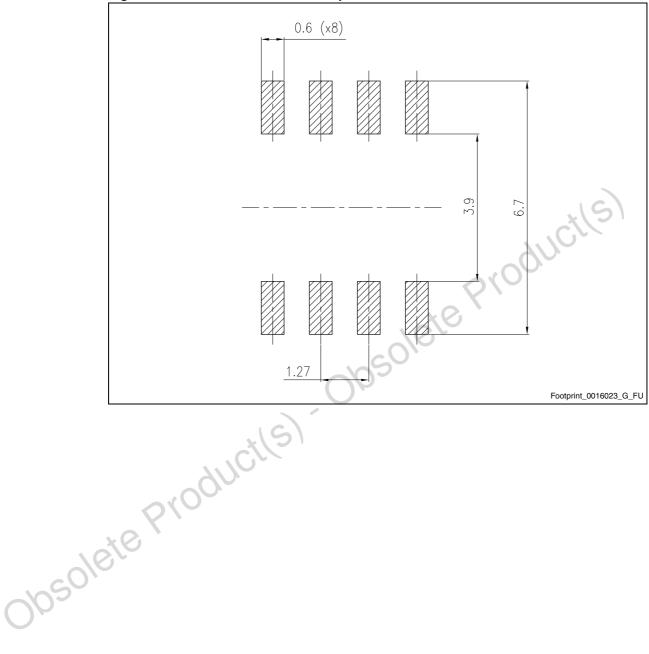


Figure 20. SO-8 recommended footprint^(a)



a. All dimensions are in millimeters.

Revision history STS4NF100

5 Revision history

Table 9. Revision history

Date	e Revision	Changes
11-Sep-2006	2006 1	First release
15-Nov-2006	2006 2	The document has been reformatted
26-Jan-2007	2007 3	Typo mistake on <i>Table 3</i> .
19-Nov-2012	2012 4	Changed: marking in cover page
ie Pro	, codiuci	Changed: marking in cover page Changed: marking in cover page Product(S)

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